

## Middle Power LED Series 5630

# LM561Y



Improved efficacy and performance of LM561B to provide better solution



### Features & Benefits

- 0.3 W class middle power LED
- Mold resin for high reliability
- Standard form factor for design flexibility (5.6 × 3.0 mm)



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## 1. Characteristics

### a) Absolute Maximum Rating

Item	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	T <sub>a</sub>	-40 ~ +85	°C	-
Storage Temperature	T <sub>stg</sub>	-40 ~ +120	°C	-
LED Junction Temperature	T <sub>j</sub>	110	°C	-
Forward Current	I <sub>F</sub>	180	mA	-
Peak Pulsed Forward Current	I <sub>p</sub>	300	mA	Duty 1/10, pulse width 10 ms
Assembly Process Temperature	-	260 <10	°C s	-
ESD (HBM)	-	±5	kV	-



**b) Electro-optical Characteristics (I<sub>F</sub> = 65 mA, T<sub>s</sub> = 25 °C)**

Item	Unit	CRI (R <sub>a</sub> ) Min.	Nominal CCT (K)	Rank	Bin	Min.	Typ.	Max.		
Forward Voltage (V <sub>F</sub> )	V	WA	AZ	2.7	-	2.8				
			A1	2.8	-	2.9				
			A2	2.9	-	3.0				
			A3	3.0	-	3.1				
				2700	S4	30.0	-	32.0		
				3000	S4	30.5	-	32.5		
				3500	S4	31.0	-	33.0		
				4000	S4	32.0	-	34.0		
				5000	S4	33.0	-	35.0		
				5700	S4	32.5	-	34.5		
				6500	S4	32.0	-	34.0		
Reverse Voltage (@ 5 mA)	V					0.7	-	1.2		
Color Rendering Index (R <sub>a</sub> )	-		5			80	-	-		
Special CRI (R9)	-					0	-	-		
Thermal Resistance (junction to solder point)	°C/W					-	15	-		
Beam Angle	°					-	120	-		

**Note:**

Samsung maintains measurement tolerance of: forward voltage = ±0.1 V, luminous flux = ±5 %, CRI = ±3, R9 = ±6.5



## 2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18			
S	P	M	W	H	T	5	4	1	M	Y	5	W	K	R	K	S	4			
Digit	PKG Information					Code	Specification													
1 2 3	Samsung Package Middle Power					SPM														
4 5	Color					WH	White													
6	Product Version					T														
7 8 9	Form Factor					541	5.6 x 3.0 x 0.7 mm; 4 pads;													
10	Sorting Current (mA)					M	65 mA													
11	Chromaticity Coordinates					Y														
12	CRI					5	Min. 80													
						7	Min. 90													
13 14	Forward Voltage (V)					WA	2.7~3.2V (2,500 pcs/Reel)													
						WK	2.7~3.2V (10,000 pcs/Reel)													
15 16	CCT (K)					W☆	2700	W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG												
						V☆	3000	V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG												
						U☆	3500	U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG												
						T☆	4000	Bin Code:	T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG											
						R☆	5000		R1, R2, R3, R4, R5, R6, R7, R8, R9, RA, RB, RC, RD, RE, RF, RG											
						Q☆	5700		Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9, QA, QB, QC, QD, QE, QF, QG											
						P☆	6500		P1, P2, P3, P4, P5, P6, P7, P8, P9, PA, PB, PC, PD, PE, PF, PG											
						☆ : Warm white: "0" (Whole bin) "M" (Quarter bin) or "K" (Kitting bin)														
17 18	Luminous Flux					S4	Bin Code: S4													



a) Luminous Flux Bins( $I_F = 65 \text{ mA}$ ,  $T_s = 25^\circ\text{C}$ )

CRI ( $R_a$ Min.)	Nominal CCT (K)	Product Code	Flux Bin	Flux Range ( $\Phi_v$ , lm)
	2700	SPMWHT541MY5W◆W☆S4	S4	30.0 ~ 32.0
	3000	SPMWHT541MY5W◆V☆S4	S4	30.5 ~ 32.5
	3500	SPMWHT541MY5W◆U☆S4	S4	31.0 ~ 33.0
80	4000	SPMWHT541MY5W◆T☆S4	S4	32.0 ~ 34.0
	5000	SPMWHT541MY5W◆R☆S4	S4	33.0 ~ 35.0
	5700	SPMWHT541MY5W◆Q☆S4	S4	32.5 ~ 34.5
	6500	SPMWHT541MY5W◆P☆S4	S4	32.0 ~ 34.0

**Note:**

"◆" can be "A" (2,500pcs) or "K" (10,000pcs) of reel taping

"☆" can be "0" (Whole bin), "M" (Quarter bin) or "K" (Kitting bin) of the color binning

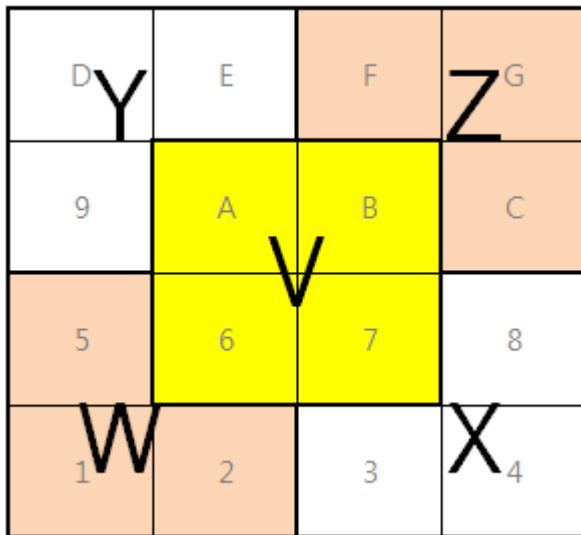


## b) Kitting rule

### 1) Kitting bin Concept

- Under agreement between customer and SAMSUNG ELECTRONICS, SAMSUNG can supply kitting bin (VF, Color, Im).
- A forward voltage (VF) of kitting bin is combined by a pair of same VF rank such as (A1+A1), (A2+A2), (A3+A3) or (AZ+AZ).
- A Chromaticity Coordinates of kitting bin is mixed by kitting procedure.(below kitting simulation)

### [Kitting example]



### [Binning Information]

	Bin #1	Bin #2
VF	AZ	AZ
	A1	A1
	A2	A2
	A3	A3
CIE	W (1, 2, 5 bin)	Z (C, F, G bin)
	V (6, 7, A, B bin)	V (6, 7, A, B bin)
	X (3, 4, 8 bin)	Y (9, D, E bin )
IV	S4	S4

※ Each of V,W,X,Y and Z can be one bin without details division.

**c) Color Bins ( $I_F = 65 \text{ mA}$ ,  $T_s = 25^\circ\text{C}$ )**

CRI ( $R_a$ ) Min.	Nominal CCT (K)	Product Code	Color Rank	Chromaticity Bins
80	2700	SPMWHT541MY5W◆W0S4	W0 (Whole bin)	W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG
		SPMWHT541MY5W◆WMS4	WM (Quarter bin)	W6, W7, WA, WB
		SPMWHT541MY5W◆WKS4	WK (Kitting bin)	WV, WW, WX, WY, WZ
		SPMWHT541MY5W◆WNS4	WN (Quarter cross kitting bin)	W6, W7, WA, WB
	3000	SPMWHT541MY5W◆V0S4	V0 (Whole bin)	V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG
		SPMWHT541MY5W◆VMS4	VM (Quarter bin)	V6, V7, VA, VB
		SPMWHT541MY5W◆VKS4	VK (Kitting bin)	VV, VW, VX, VY, VZ
		SPMWHT541MY5W◆VNS4	VN (Quarter cross kitting bin)	V6, V7, VA, VB
	3500	SPMWHT541MY5W◆U0S4	U0 (Whole bin)	U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF,UG
		SPMWHT541MY5W◆UMS4	UM (Quarter bin)	U6, U7, UA, UB
		SPMWHT541MY5W◆UKS4	UK (Kitting bin)	UV, UW, UX, UY, UZ
		SPMWHT541MY5W◆UNS4	UN (Quarter cross kitting bin)	U6, U7, UA, UB
5700	4000	SPMWHT541MY5W◆T0S4	T0 (Whole bin)	T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG
		SPMWHT541MY5W◆TMS4	TM (Quarter bin)	T6, T7, TA, TB
		SPMWHT541MY5W◆TKS4	TK (Kitting bin)	TV, TW, TX, TY, TZ
		SPMWHT541MY5W◆TNS4	TN (Quarter cross kitting bin)	T6, T7, TA, TB
	5000	SPMWHT541MY5W◆R0S4	R0 (Whole bin)	R1, R2, R3, R4, R5, R6, R7, R8, R9, RA, RB, RC, RD, RE, RF, RG
		SPMWHT541MY5W◆RKS4	RK (Kitting bin)	RV, RW, RX, RY, RZ
		SPMWHT541MY5W◆Q0S4	Q0 (Whole bin)	Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9, QA, QB, QC, QD, QE, QF, QG
		SPMWHT541MY5W◆QKS4	QK (Kitting bin)	QV, QW, QX, QY, QZ
	6500	SPMWHT541MY5W◆P0S4	P0 (Whole bin)	P1, P2, P3, P4, P5, P6, P7, P8, P9, PA, PB, PC, PD, PE, PF, PG
		SPMWHT541MY5W◆PKS4	PK (Kitting bin)	PV, PW, PX, PY, PZ

**Note:**

"◆" can be "A" (2,500pcs) or "K" (10,000pcs) of reel taping

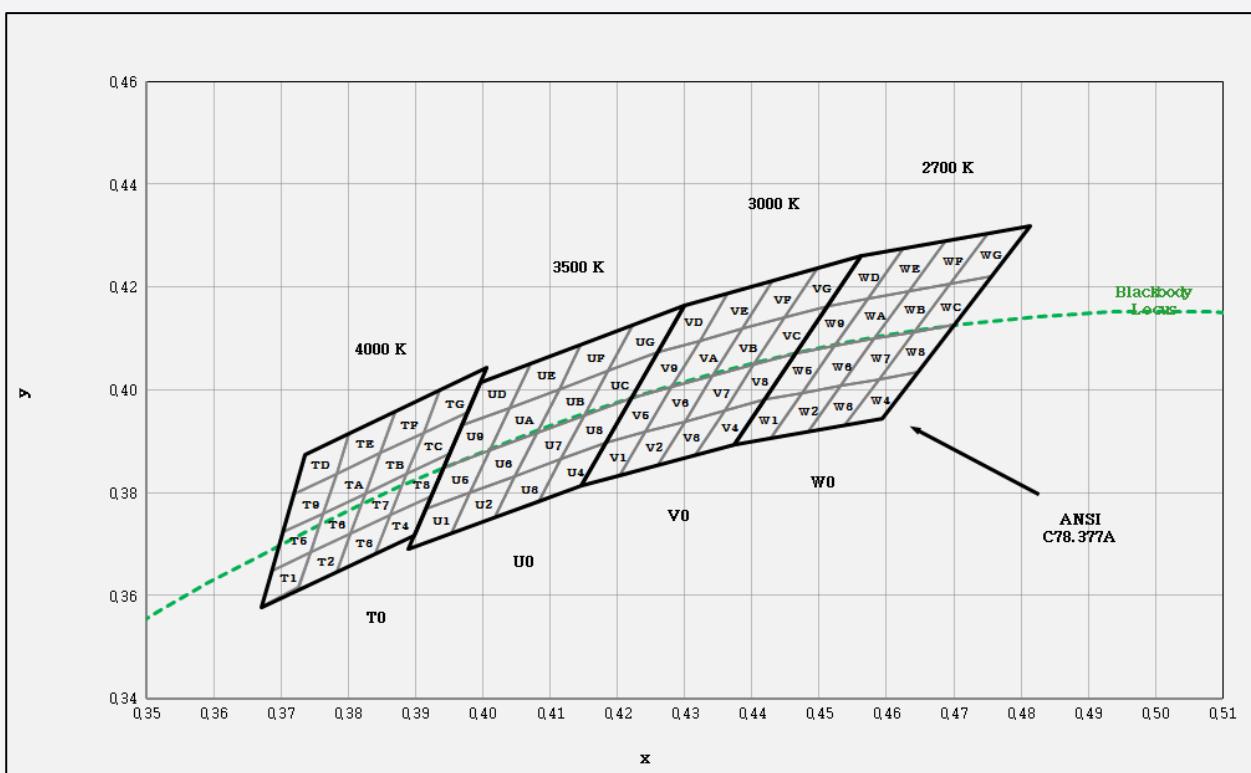
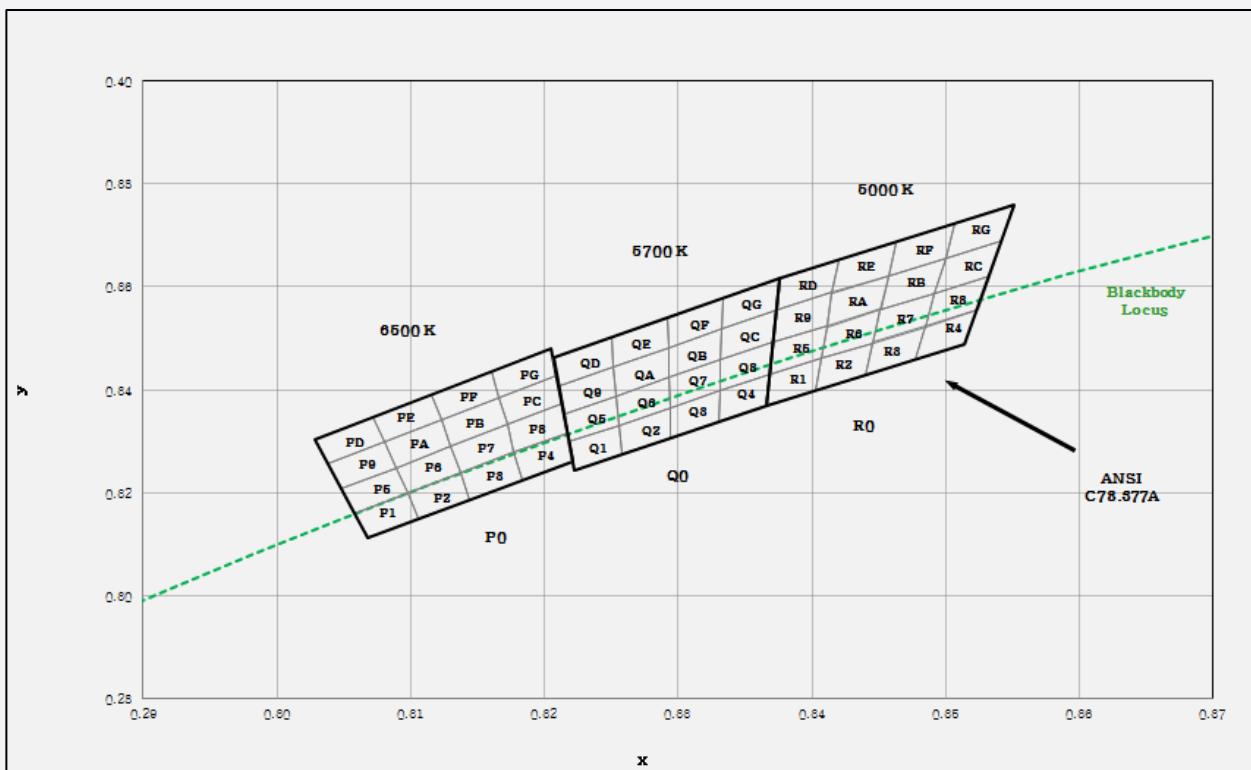


d) Voltage Bins ( $I_F = 65 \text{ mA}$ ,  $T_s = 25^\circ\text{C}$ )

CRI ( $R_a$ ) Min.	Nominal CCT (K)	Product Code  WA (WK)	Voltage Rank	Voltage Bin	Voltage Range (V)
-	-	-	AZ		2.7 ~ 2.8
-	-	-	A1		2.8 ~ 2.9
-	-	-	A2		2.9 ~ 3.0
-	-	-	A3		3.0 ~ 3.1



e) Chromaticity Region & Coordinates ( $I_F = 65 \text{ mA}$ ,  $T_s = 25^\circ\text{C}$ )



e) Chromaticity Region & Coordinates ( $I_F = 65 \text{ mA}$ ,  $T_s = 25^\circ\text{C}$ )

Region	CIE x	CIE y	Region	CIE x	CIE y
W rank (2700 K)					
W1	0.4373	0.3893	W9	0.4465	0.4071
	0.4418	0.3981		0.4513	0.4164
	0.4475	0.3994		0.4573	0.4178
	0.4428	0.3906		0.4523	0.4085
W2	0.4428	0.3906	WA	0.4523	0.4085
	0.4475	0.3994		0.4573	0.4178
	0.4532	0.4008		0.4634	0.4193
	0.4483	0.3919		0.4582	0.4099
W3	0.4483	0.3919	WB	0.4582	0.4099
	0.4532	0.4008		0.4634	0.4193
	0.4589	0.4021		0.4695	0.4207
	0.4538	0.3931		0.4641	0.4112
W4	0.4538	0.3931	WC	0.4641	0.4112
	0.4589	0.4021		0.4695	0.4207
	0.4646	0.4034		0.4756	0.4221
	0.4593	0.3944		0.4700	0.4126
W5	0.4418	0.3981	WD	0.4513	0.4164
	0.4465	0.4071		0.4562	0.4260
	0.4523	0.4085		0.4624	0.4274
	0.4475	0.3994		0.4573	0.4178
W6	0.4475	0.3994	WE	0.4573	0.4178
	0.4523	0.4085		0.4624	0.4274
	0.4582	0.4099		0.4687	0.4289
	0.4532	0.4008		0.4634	0.4193
W7	0.4532	0.4008	WF	0.4634	0.4193
	0.4582	0.4099		0.4687	0.4289
	0.4641	0.4112		0.4750	0.4304
	0.4589	0.4021		0.4695	0.4207
W8	0.4589	0.4021	WG	0.4695	0.4207
	0.4641	0.4112		0.4750	0.4304
	0.4700	0.4126		0.4813	0.4319
	0.4646	0.4034		0.4756	0.4221

Region	CIE x	CIE y	Region	CIE x	CIE y
V rank (3000 K)					
V1	0.4147	0.3814	V9	0.4221	0.3984
	0.4183	0.3898		0.4259	0.4073
	0.4242	0.3919		0.4322	0.4096
	0.4203	0.3833		0.4281	0.4006
V2	0.4203	0.3833	VA	0.4281	0.4006
	0.4242	0.3919		0.4322	0.4096
	0.4300	0.3939		0.4385	0.4119
	0.4259	0.3853		0.4342	0.4028
V3	0.4259	0.3853	VB	0.4342	0.4028
	0.4300	0.3939		0.4385	0.4119
	0.4359	0.3960		0.4449	0.4141
	0.4316	0.3873		0.4403	0.4049
V4	0.4316	0.3873	VC	0.4403	0.4049
	0.4359	0.3960		0.4449	0.4141
	0.4418	0.3981		0.4513	0.4164
	0.4373	0.3893		0.4465	0.4071
V5	0.4183	0.3898	VD	0.4259	0.4073
	0.4221	0.3984		0.4299	0.4165
	0.4281	0.4006		0.4364	0.4188
	0.4242	0.3919		0.4322	0.4096
V6	0.4242	0.3919	VE	0.4322	0.4096
	0.4281	0.4006		0.4364	0.4188
	0.4342	0.4028		0.4430	0.4212
	0.4300	0.3939		0.4385	0.4119
V7	0.4300	0.3939	VF	0.4385	0.4119
	0.4342	0.4028		0.4430	0.4212
	0.4403	0.4049		0.4496	0.4236
	0.4359	0.3960		0.4449	0.4141
V8	0.4359	0.3960	VG	0.4449	0.4141
	0.4403	0.4049		0.4496	0.4236
	0.4465	0.4071		0.4562	0.4260
	0.4418	0.3981		0.4513	0.4164



### e) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
U rank (3500 K)					
U1	0.3889	0.3690	U9	0.3941	0.3848
	0.3915	0.3768		0.3968	0.3930
	0.3981	0.3800		0.4040	0.3966
	0.3953	0.3720		0.4010	0.3882
U2	0.3953	0.3720	UA	0.4010	0.3882
	0.3981	0.3800		0.4040	0.3966
	0.4048	0.3832		0.4113	0.4001
	0.4017	0.3751		0.4080	0.3916
U3	0.4017	0.3751	UB	0.4080	0.3916
	0.4048	0.3832		0.4113	0.4001
	0.4116	0.3865		0.4186	0.4037
	0.4082	0.3782		0.4150	0.3950
U4	0.4082	0.3782	UC	0.4150	0.3950
	0.4116	0.3865		0.4186	0.4037
	0.4183	0.3898		0.4259	0.4073
	0.4147	0.3814		0.4221	0.3984
U5	0.3915	0.3768	UD	0.3968	0.3930
	0.3941	0.3848		0.3996	0.4015
	0.4010	0.3882		0.4071	0.4052
	0.3981	0.3800		0.4040	0.3966
U6	0.3981	0.3800	UE	0.4040	0.3966
	0.4010	0.3882		0.4071	0.4052
	0.4080	0.3916		0.4146	0.4089
	0.4048	0.3832		0.4113	0.4001
U7	0.4048	0.3832	UF	0.4113	0.4001
	0.4080	0.3916		0.4146	0.4089
	0.4150	0.3950		0.4222	0.4127
	0.4116	0.3865		0.4186	0.4037
U8	0.4116	0.3865	UG	0.4186	0.4037
	0.4150	0.3950		0.4222	0.4127
	0.4221	0.3984		0.4299	0.4165
	0.4183	0.3898		0.4259	0.4073

Region	CIE x	CIE y	Region	CIE x	CIE y
T rank (4000 K)					
T1	0.3670	0.3578	T9	0.3702	0.3722
	0.3726	0.3612		0.3763	0.3760
	0.3744	0.3685		0.3782	0.3837
	0.3686	0.3649		0.3719	0.3797
T2	0.3726	0.3612	TA	0.3763	0.3760
	0.3783	0.3646		0.3825	0.3798
	0.3804	0.3721		0.3847	0.3877
	0.3744	0.3685		0.3782	0.3837
T3	0.3783	0.3646	TB	0.3825	0.3798
	0.3840	0.3681		0.3887	0.3836
	0.3863	0.3758		0.3912	0.3917
	0.3804	0.3721		0.3847	0.3877
T4	0.3840	0.3681	TC	0.3887	0.3836
	0.3898	0.3716		0.3950	0.3875
	0.3924	0.3794		0.3978	0.3958
	0.3863	0.3758		0.3912	0.3917
T5	0.3686	0.3649	TD	0.3719	0.3797
	0.3744	0.3685		0.3782	0.3837
	0.3763	0.3760		0.3802	0.3916
	0.3702	0.3722		0.3736	0.3874
T6	0.3744	0.3685	TE	0.3782	0.3837
	0.3804	0.3721		0.3847	0.3877
	0.3825	0.3798		0.3869	0.3958
	0.3763	0.3760		0.3802	0.3916
T7	0.3804	0.3721	TF	0.3847	0.3877
	0.3863	0.3758		0.3912	0.3917
	0.3887	0.3836		0.3937	0.4001
	0.3825	0.3798		0.3869	0.3958
T8	0.3863	0.3758	TG	0.3912	0.3917
	0.3924	0.3794		0.3978	0.3958
	0.3950	0.3875		0.4006	0.4044
	0.3887	0.3836		0.3937	0.4001



### e) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
R rank (5000 K)					
R1	0.3366	0.3369	R9	0.3374	0.3554
	0.3369	0.3431		0.3371	0.3493
	0.3407	0.3460		0.3411	0.3522
	0.3403	0.3398		0.3415	0.3587
R2	0.3403	0.3398	RA	0.3415	0.3587
	0.3407	0.3460		0.3411	0.3522
	0.3446	0.3491		0.3451	0.3554
	0.3440	0.3427		0.3457	0.3621
R3	0.3446	0.3491	RB	0.3451	0.3554
	0.3440	0.3427		0.3457	0.3621
	0.3477	0.3458		0.3500	0.3655
	0.3485	0.3522		0.3492	0.3587
R4	0.3485	0.3522	RC	0.3492	0.3587
	0.3477	0.3458		0.3500	0.3655
	0.3514	0.3487		0.3542	0.3690
	0.3524	0.3554		0.3533	0.3620
R5	0.3371	0.3493	RD	0.3376	0.3616
	0.3369	0.3431		0.3374	0.3554
	0.3407	0.3460		0.3415	0.3587
	0.3411	0.3522		0.3420	0.3652
R6	0.3407	0.3460	RE	0.3415	0.3587
	0.3411	0.3522		0.3420	0.3652
	0.3451	0.3554		0.3463	0.3687
	0.3446	0.3491		0.3457	0.3621
R7	0.3446	0.3491	RF	0.3457	0.3621
	0.3451	0.3554		0.3463	0.3687
	0.3492	0.3587		0.3507	0.3724
	0.3485	0.3522		0.3500	0.3655
R8	0.3485	0.3522	RG	0.3500	0.3655
	0.3492	0.3587		0.3507	0.3724
	0.3533	0.3620		0.3551	0.3760
	0.3524	0.3554		0.3542	0.3690

Region	CIE x	CIE y	Region	CIE x	CIE y
Q rank (5700 K)					
Q1	0.3218	0.3298	Q9	0.3211	0.3407
	0.3222	0.3243		0.3215	0.3353
	0.3258	0.3275		0.3254	0.3388
	0.3256	0.3331		0.3252	0.3444
Q2	0.3256	0.3331	QA	0.3252	0.3444
	0.3258	0.3275		0.3254	0.3388
	0.3294	0.3306		0.3293	0.3423
	0.3294	0.3364		0.3293	0.3481
Q3	0.3294	0.3364	QB	0.3293	0.3481
	0.3294	0.3306		0.3293	0.3423
	0.3330	0.3338		0.3332	0.3458
	0.3331	0.3398		0.3333	0.3518
Q4	0.3331	0.3398	QC	0.3333	0.3518
	0.3330	0.3338		0.3332	0.3458
	0.3366	0.3369		0.3371	0.3493
	0.3369	0.3431		0.3374	0.3554
Q5	0.3215	0.3353	QD	0.3207	0.3462
	0.3218	0.3298		0.3211	0.3407
	0.3256	0.3331		0.3252	0.3444
	0.3254	0.3388		0.3250	0.3501
Q6	0.3254	0.3388	QE	0.3250	0.3501
	0.3256	0.3331		0.3252	0.3444
	0.3294	0.3364		0.3293	0.3481
	0.3293	0.3423		0.3292	0.3539
Q7	0.3293	0.3423	QF	0.3292	0.3539
	0.3294	0.3364		0.3293	0.3481
	0.3331	0.3398		0.3333	0.3518
	0.3332	0.3458		0.3334	0.3578
Q8	0.3332	0.3458	QG	0.3334	0.3578
	0.3331	0.3398		0.3333	0.3518
	0.3369	0.3431		0.3374	0.3554
	0.3371	0.3493		0.3376	0.3616



### e) Chromaticity Region & Coordinates

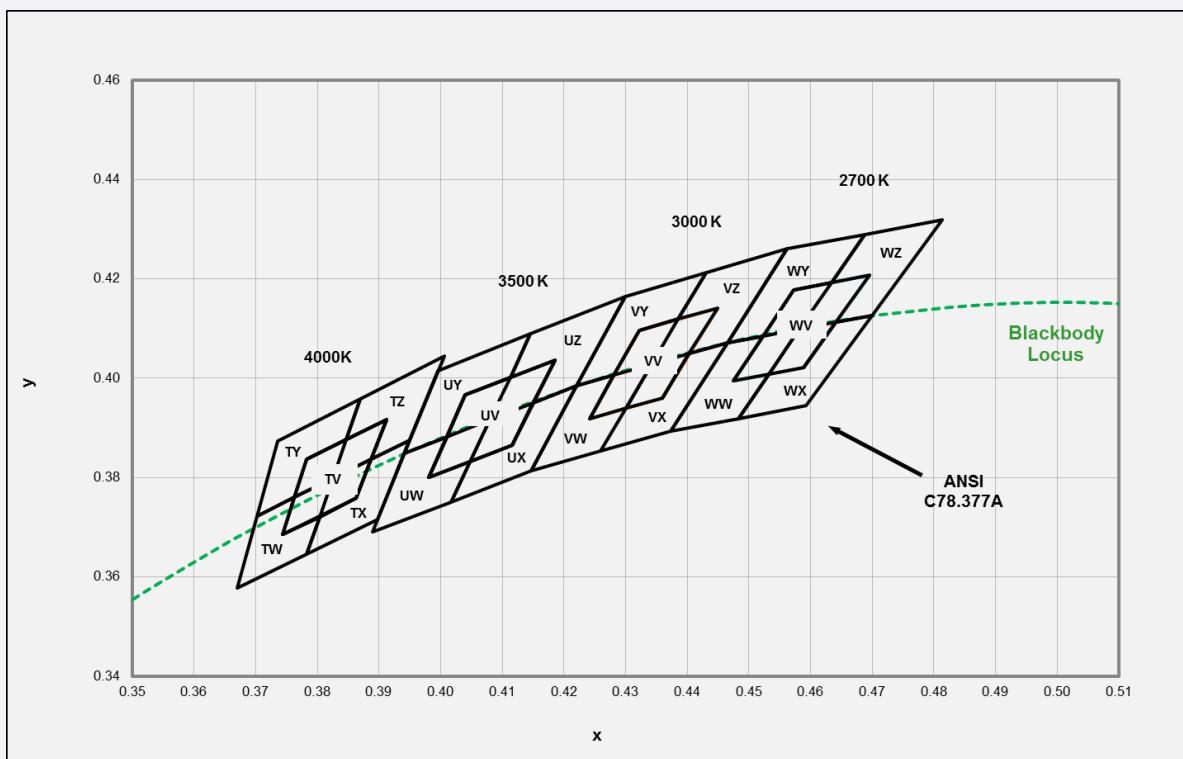
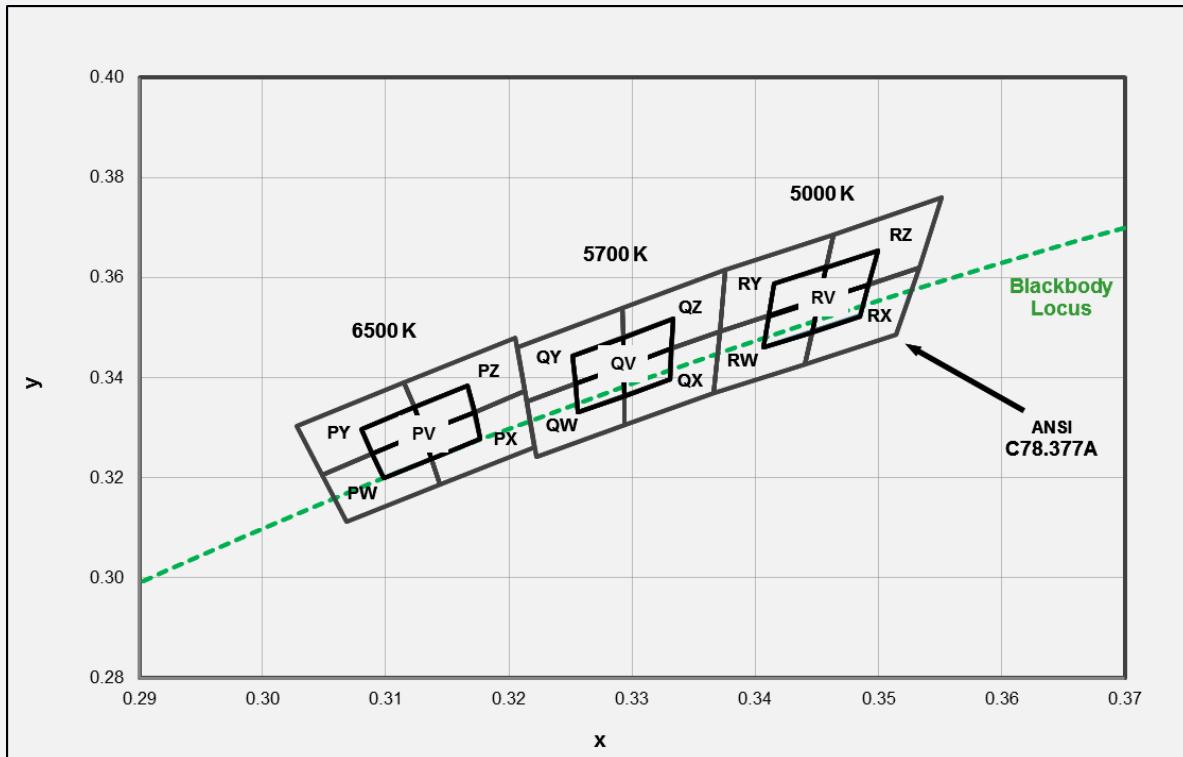
Region	CIE x	CIE y	Region	CIE x	CIE y
P rank (6500 K)					
P1	0.3068	0.3113	P9	0.3048	0.3207
	0.3106	0.3150		0.3089	0.3249
	0.3098	0.3199		0.3080	0.3298
	0.3058	0.3160		0.3038	0.3256
P2	0.3106	0.3150	PA	0.3089	0.3249
	0.3144	0.3186		0.3130	0.3290
	0.3137	0.3238		0.3123	0.3341
	0.3098	0.3199		0.3080	0.3298
P3	0.3144	0.3186	PB	0.3130	0.3290
	0.3183	0.3224		0.3172	0.3332
	0.3177	0.3278		0.3166	0.3384
	0.3137	0.3238		0.3123	0.3341
P4	0.3183	0.3224	PC	0.3172	0.3332
	0.3221	0.3261		0.3214	0.3373
	0.3218	0.3317		0.3210	0.3427
	0.3177	0.3278		0.3166	0.3384
P5	0.3058	0.3160	PD	0.3038	0.3256
	0.3098	0.3199		0.3080	0.3298
	0.3089	0.3249		0.3072	0.3348
	0.3048	0.3207		0.3028	0.3304
P6	0.3098	0.3199	PE	0.3080	0.3298
	0.3137	0.3238		0.3123	0.3341
	0.3130	0.3290		0.3115	0.3391
	0.3089	0.3249		0.3072	0.3348
P7	0.3137	0.3238	PF	0.3123	0.3341
	0.3177	0.3278		0.3166	0.3384
	0.3172	0.3332		0.3160	0.3436
	0.3130	0.3290		0.3115	0.3391
P8	0.3177	0.3278	PG	0.3166	0.3384
	0.3218	0.3317		0.3210	0.3427
	0.3214	0.3373		0.3206	0.3481
	0.3172	0.3332		0.3160	0.3436

**Note:**

Samsung maintains measurement tolerance of: Cx, Cy = ±0.005



f) Kintting Chromaticity Region & Coordinates ( $I_F = 65 \text{ mA}$ ,  $T_s = 25^\circ\text{C}$ )



f) Kintting Chromaticity Region & Coordinates ( $I_F = 65 \text{ mA}$ ,  $T_s = 25^\circ\text{C}$ )

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>W rank (2700 K)</b>					
WV	0.4475	0.3994	WY	0.4465	0.4071
	0.4589	0.4021		0.4523	0.4085
	0.4695	0.4207		0.4573	0.4178
	0.4573	0.4178		0.4634	0.4193
WW	0.4373	0.3893	WZ	0.4687	0.4289
	0.4483	0.3919		0.4562	0.4260
	0.4532	0.4008		0.4641	0.4112
	0.4475	0.3994		0.4700	0.4126
	0.4523	0.4085		0.4813	0.4319
	0.4465	0.4071		0.4687	0.4289
WX	0.4483	0.3919		0.4634	0.4193
	0.4593	0.3944		0.4695	0.4207
	0.4700	0.4126			
	0.4641	0.4112			
	0.4589	0.4021			
	0.4532	0.4008			

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>V rank (3000 K)</b>					
VV	0.4242	0.3919	VY	0.4147	0.3814
	0.4359	0.3960		0.4259	0.3853
	0.4449	0.4141		0.4300	0.3939
	0.4322	0.4096		0.4242	0.3919
VW	0.4221	0.3984	VZ	0.4281	0.4006
	0.4281	0.4006		0.4322	0.4096
	0.4385	0.4119		0.4430	0.4212
	0.4299	0.4165		0.4221	0.3984
	0.4403	0.4049		0.4259	0.3853
	0.4465	0.4071		0.4373	0.3893
VX	0.4562	0.4260		0.4465	0.4071
	0.4430	0.4212		0.4403	0.4049
	0.4385	0.4119		0.4359	0.3960
	0.4449	0.4141		0.4300	0.3939



### f) Kintting Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>U rank (3500 K)</b>					
UV	0.3981	0.3800	UY	0.3941	0.3848
	0.4116	0.3865		0.4010	0.3882
	0.4186	0.4037		0.4040	0.3966
	0.4040	0.3966		0.4113	0.4001
UW	0.3889	0.3690		0.4146	0.4089
	0.4017	0.3751		0.3996	0.4015
	0.4048	0.3832		0.4150	0.3950
	0.3981	0.3800		0.4221	0.3984
	0.4010	0.3882		0.4299	0.4165
	0.3941	0.3848		0.4146	0.4089
UX	0.4017	0.3751	UZ	0.4113	0.4001
	0.4147	0.3814		0.4186	0.4037
	0.4221	0.3984		0.4150	0.3950
	0.4150	0.3950		0.4221	0.3984
	0.4116	0.3865		0.4299	0.4165
	0.4048	0.3832		0.4146	0.4089

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>T rank (4000 K)</b>					
TV	0.3744	0.3685	TY	0.3670	0.3578
	0.3863	0.3758		0.3783	0.3646
	0.3912	0.3917		0.3804	0.3721
	0.3782	0.3837		0.3744	0.3685
TW	0.3670	0.3578	TZ	0.3702	0.3722
	0.3783	0.3646		0.3763	0.3760
	0.3804	0.3721		0.3782	0.3837
	0.3744	0.3685		0.3847	0.3877
	0.3763	0.3760		0.3869	0.3958
	0.3702	0.3722		0.3736	0.3874
TX	0.3783	0.3646	TZ	0.3887	0.3837
	0.3898	0.3716		0.3950	0.3875
	0.3950	0.3875		0.4006	0.4044
	0.3887	0.3837		0.3869	0.3958
	0.3863	0.3758		0.3847	0.3877
	0.3804	0.3721		0.3912	0.3917



### f) Kintting Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
R rank (5000 K)					
RV	0.3407	0.3460	RY	0.3371	0.3493
	0.3485	0.3524		0.3411	0.3525
	0.3500	0.3655		0.3415	0.3588
	0.3415	0.3588		0.3457	0.3621
RW	0.3366	0.3369		0.3463	0.3687
	0.3440	0.3427		0.3376	0.3616
	0.3446	0.3491		0.3457	0.3621
	0.3407	0.3460		0.3500	0.3655
	0.3411	0.3525		0.3492	0.3587
	0.3371	0.3493		0.3533	0.3620
RX	0.3440	0.3428	RZ	0.3533	0.3587
	0.3514	0.3487		0.3492	0.3587
	0.3533	0.3620		0.3533	0.3620
	0.3492	0.3587		0.3551	0.3760
	0.3485	0.3522		0.3463	0.3687
	0.3446	0.3493		0.3463	0.3687

Region	CIE x	CIE y	Region	CIE x	CIE y
Q rank (5700 K)					
QV	0.3256	0.3331	QY	0.3222	0.3243
	0.3331	0.3398		0.3294	0.3306
	0.3333	0.3518		0.3294	0.3364
	0.3252	0.3444		0.3256	0.3331
QW	0.3222	0.3243		0.3254	0.3388
	0.3294	0.3306		0.3252	0.3444
	0.3294	0.3364		0.3293	0.3481
	0.3256	0.3331		0.3292	0.3539
	0.3254	0.3388		0.3207	0.3462
	0.3215	0.3353		0.3291	0.3481
QX	0.3294	0.3306	QZ	0.3293	0.3481
	0.3366	0.3369		0.3333	0.3518
	0.3371	0.3493		0.3332	0.3458
	0.3332	0.3458		0.3371	0.3493
	0.3331	0.3398		0.3376	0.3616
	0.3294	0.3364		0.3292	0.3539



**f) Kintting Chromaticity Region & Coordinates**

Region	CIE x	CIE y	Region	CIE x	CIE y
<b>P rank (6500 K)</b>					
PV	0.3098	0.3199			
	0.3177	0.3278			
	0.3166	0.3384			
	0.3080	0.3298			
PW	0.3068	0.3113	PY	0.3048	0.3207
	0.3144	0.3186		0.3089	0.3249
	0.3137	0.3238		0.308	0.3298
	0.3098	0.3199		0.3123	0.3341
	0.3089	0.3249		0.3115	0.3391
	0.3048	0.3207		0.3028	0.3304
PX	0.3144	0.3186	PZ	0.3123	0.3341
	0.3221	0.3261		0.3166	0.3384
	0.3213	0.3373		0.3172	0.3332
	0.3172	0.3332		0.3213	0.3373
	0.3177	0.3278		0.3205	0.3481
	0.3137	0.3238		0.3115	0.3391

**Note:**

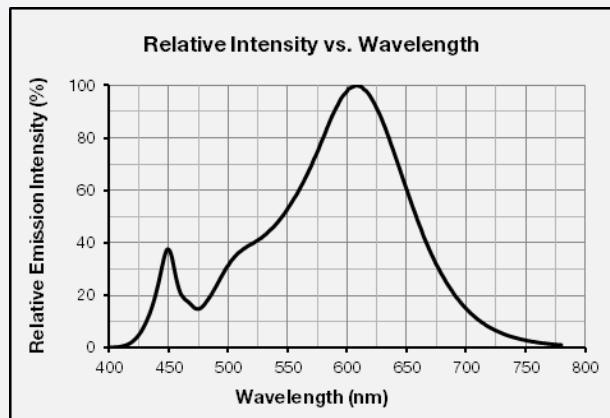
Samsung maintains measurement tolerance of: Cx, Cy = ±0.005



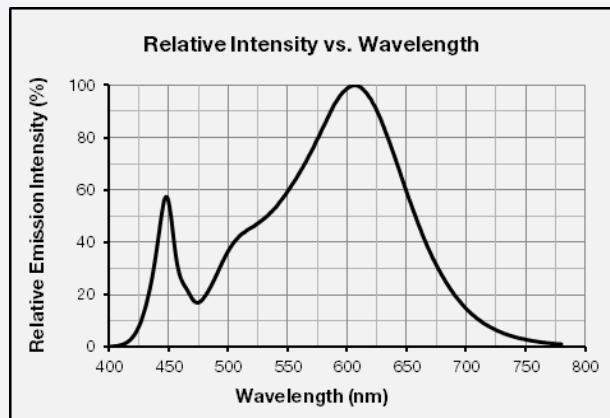
### 3. Typical Characteristics Graphs

#### a) Spectrum Distribution ( $I_F = 65 \text{ mA}$ , $T_s = 25^\circ\text{C}$ )

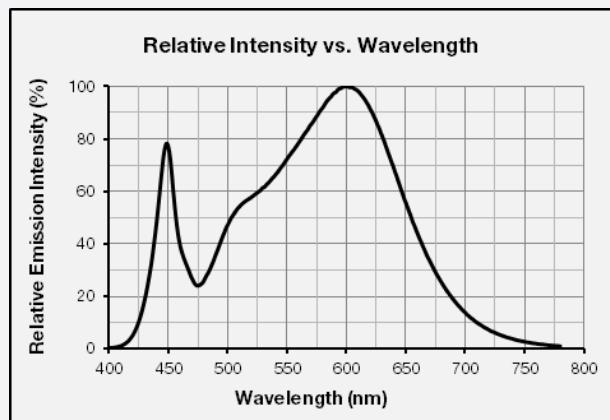
CCT: 2700 K (80 CRI)



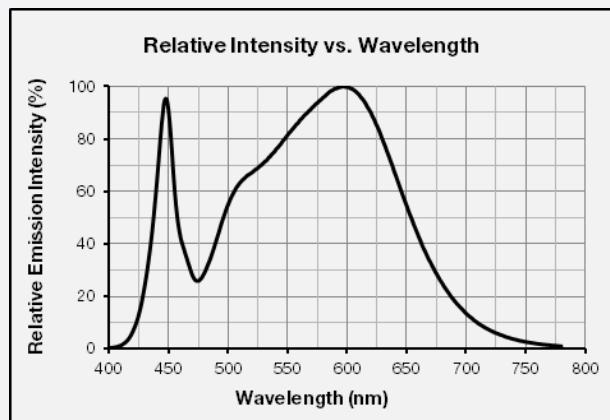
CCT: 3000 K (80 CRI)



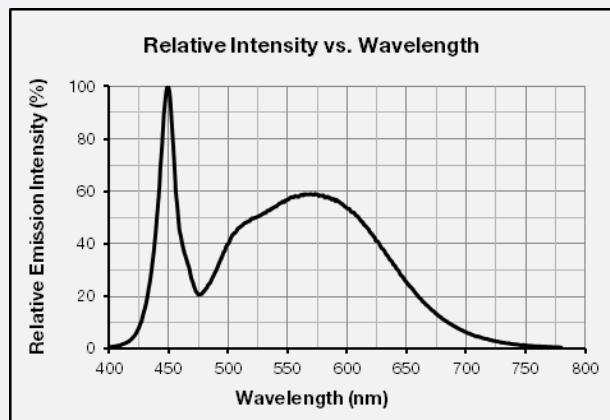
CCT: 3500 K (80 CRI)



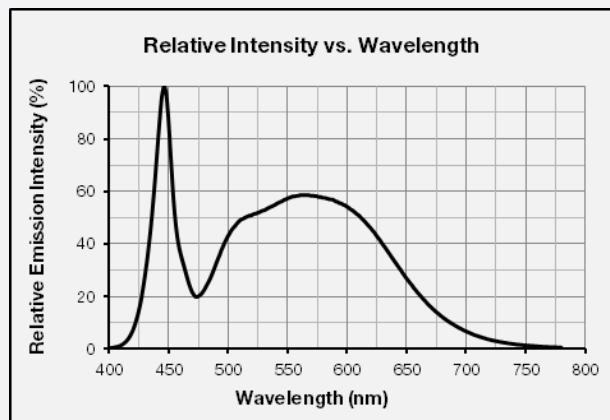
CCT: 4000 K (80 CRI)



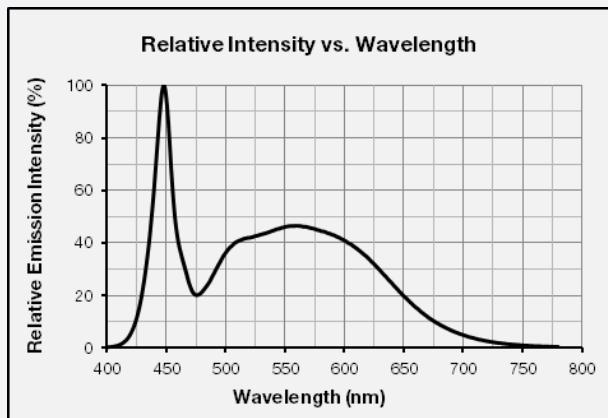
CCT: 5000 K (80 CRI)



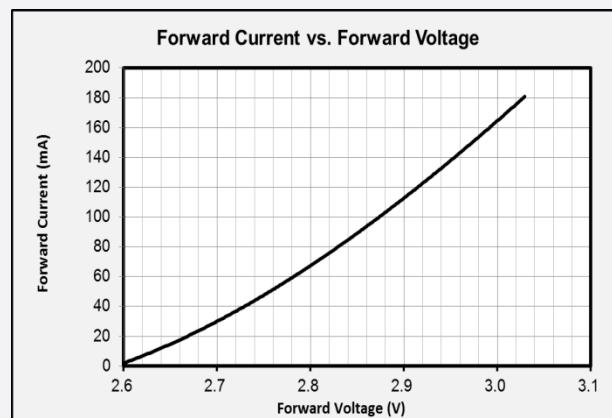
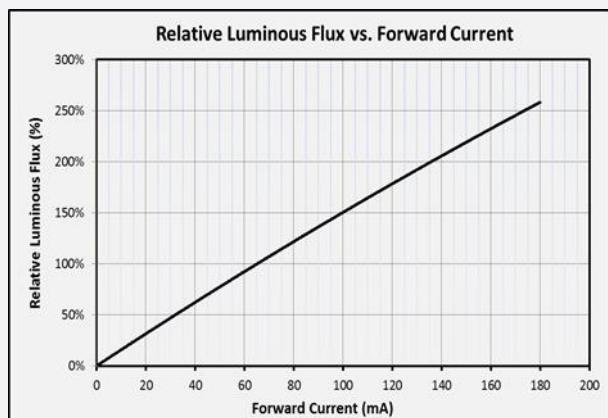
CCT: 5700 K (80 CRI)



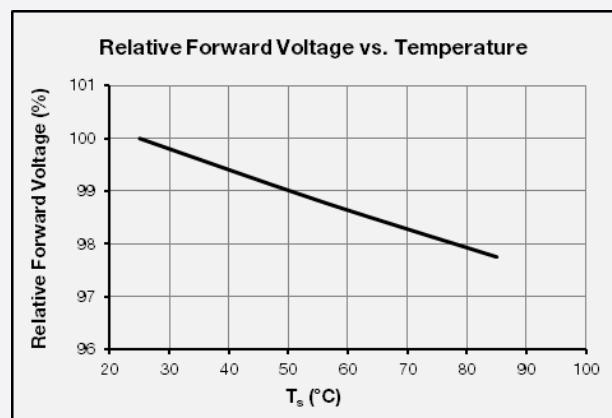
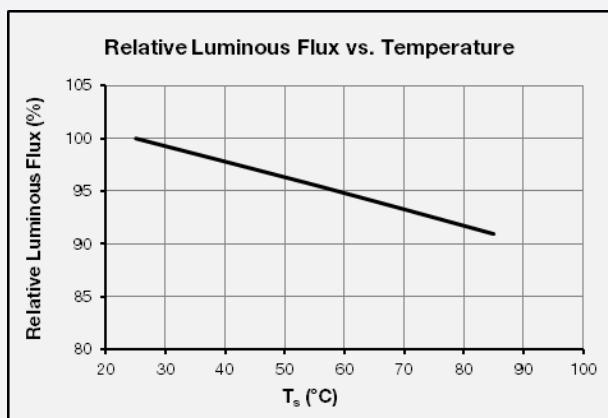
CCT: 6500 K (80 CRI)



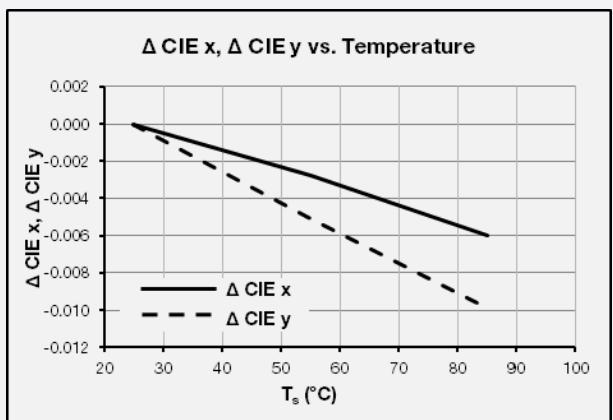
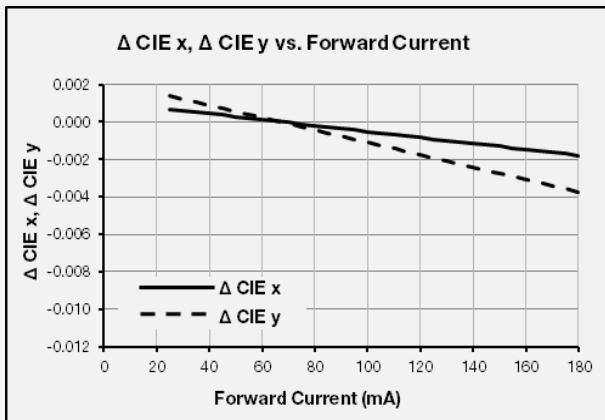
b) Forward Current Characteristics ( $T_s = 25^\circ\text{C}$ )



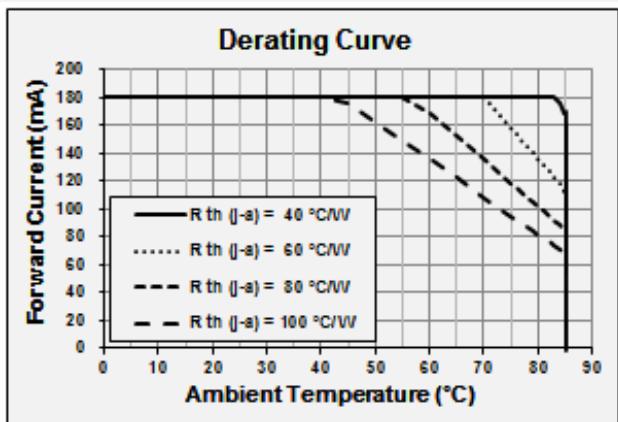
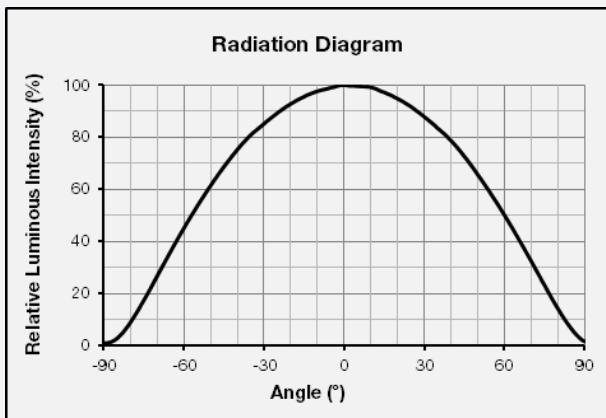
c) Temperature Characteristics ( $I_F = 65 \text{ mA}$ )



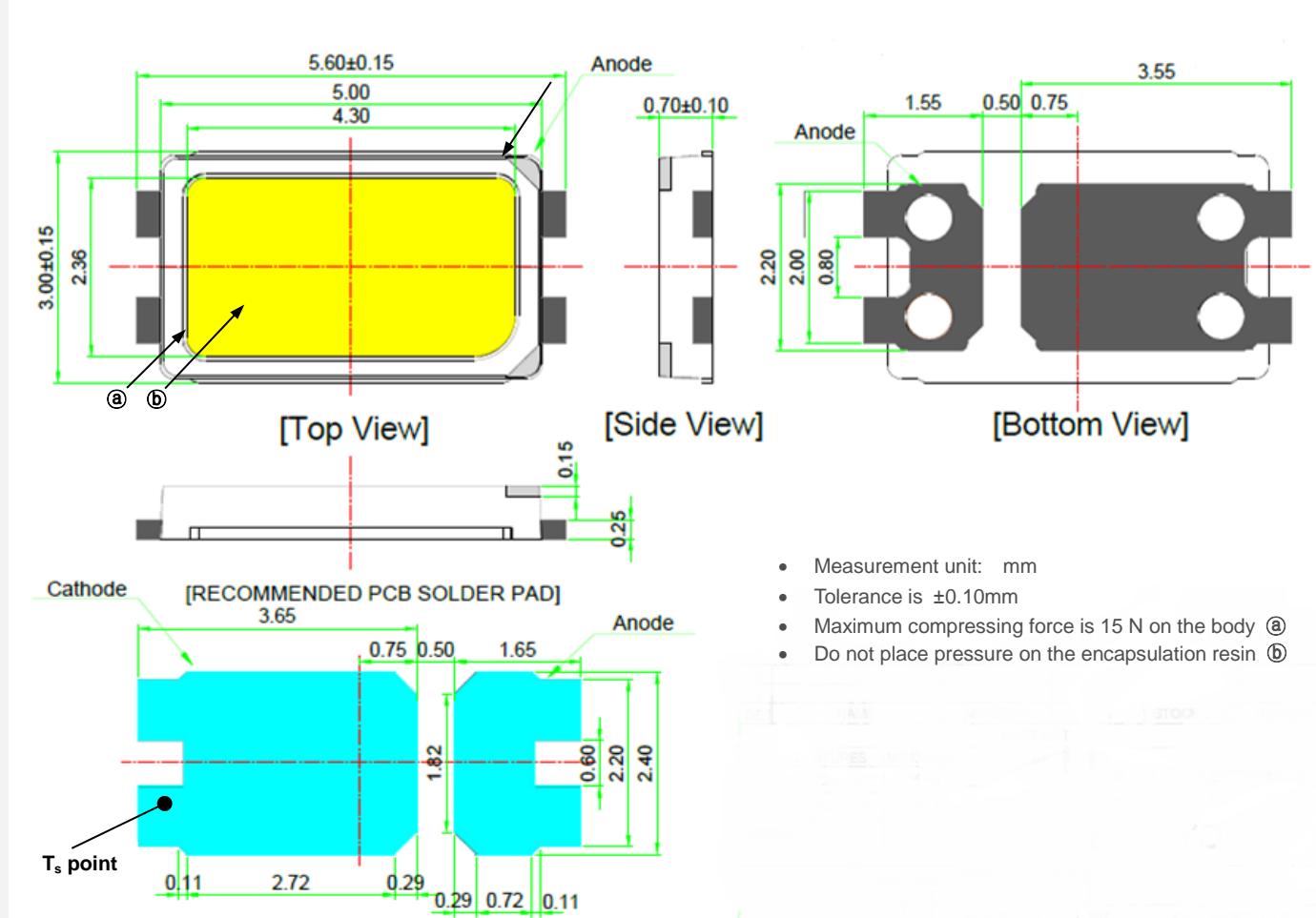
## d) Color Shift Characteristics

 $T_s = 25 \text{ }^\circ\text{C}$  $I_F = 65 \text{ mA}$ 

## e) Derating Curve

f) Beam Angle Characteristics ( $I_F = 65 \text{ mA}$ ,  $T_s = 25 \text{ }^\circ\text{C}$ )

#### 4. Outline Drawing & Dimension



##### Notes:

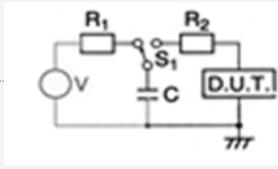
- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2)  $T_s$  point and measurement method:
  - ① Measure one point at the cathode pad, if necessary remove PSR of PCB to reach  $T_s$  point.
  - ② All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

##### Precautions:

- 1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- 3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

## 5. Reliability Test Items & Conditions

### a) Test Items

Test Item	Test Condition	Test Hour / Cycle	Sample No.
Room Temperature Life Test	25 °C, DC 180 mA	1000 h	22
High Temperature Life Test	85 °C, DC 180 mA	1000 h	22
High Temperature Humidity Life Test	60 °C, 90 % RH, DC 180 mA	1000 h	22
Low Temperature Life Test	-40 °C, DC 180 mA	1000 h	22
Powered Temperature Cycle Test	-45 °C / 20 min ↔ 85 °C / 20 min, sweep 100 min cycle on/off: each 5 min, DC 180 mA	100 cycles	22
Thermal Cycle	-45 °C / 15 min ↔ 125 °C / 15 min → Hot plate 180 °C	500 cycles	100
High Temperature Storage	120 °C	1000 h	11
Low Temperature Storage	-40 °C	1000 h	11
ESD (HBM)	 <p>R<sub>1</sub>: 10 MΩ R<sub>2</sub>: 1.5 kΩ C: 100 pF V: ±5 kV</p>	5 times	30
ESD (MM)	<p>R<sub>1</sub>: 10 MΩ R<sub>2</sub>: 0 C: 200 pF V: ±0.5 kV</p>	5 times	30
Vibration Test	20~2000~20 Hz, 200 m/s <sup>2</sup> , sweep 4 min X, Y, Z 3 direction, each 1 cycle	4 cycles	11
Mechanical Shock Test	1500 g, 0.5 ms 3 shocks each X-Y-Z axis	5 cycles	11

### b) Criteria for Judging the Damage

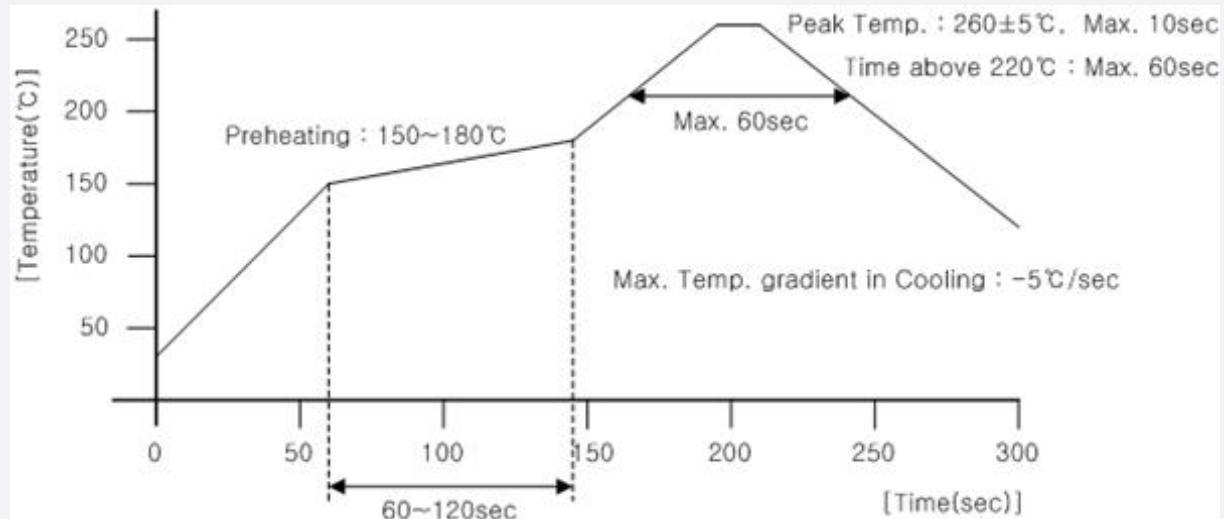
Item	Symbol	Test Condition (T <sub>s</sub> = 25 °C)	Limit	
			Min	Max
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 65 mA	Init. Value * 0.9	Init. Value * 1.1
Luminous Flux	Φ <sub>v</sub>	I <sub>F</sub> = 65 mA	Init. Value * 0.7	Init. Value * 1.1



## 6. Soldering Conditions

### a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



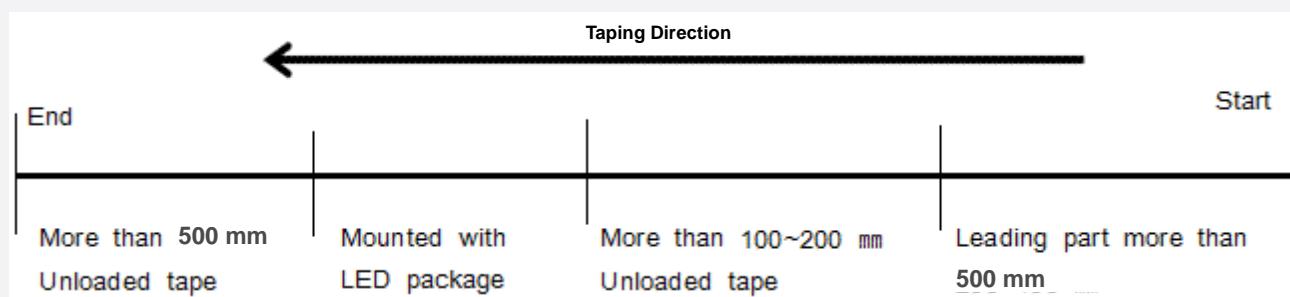
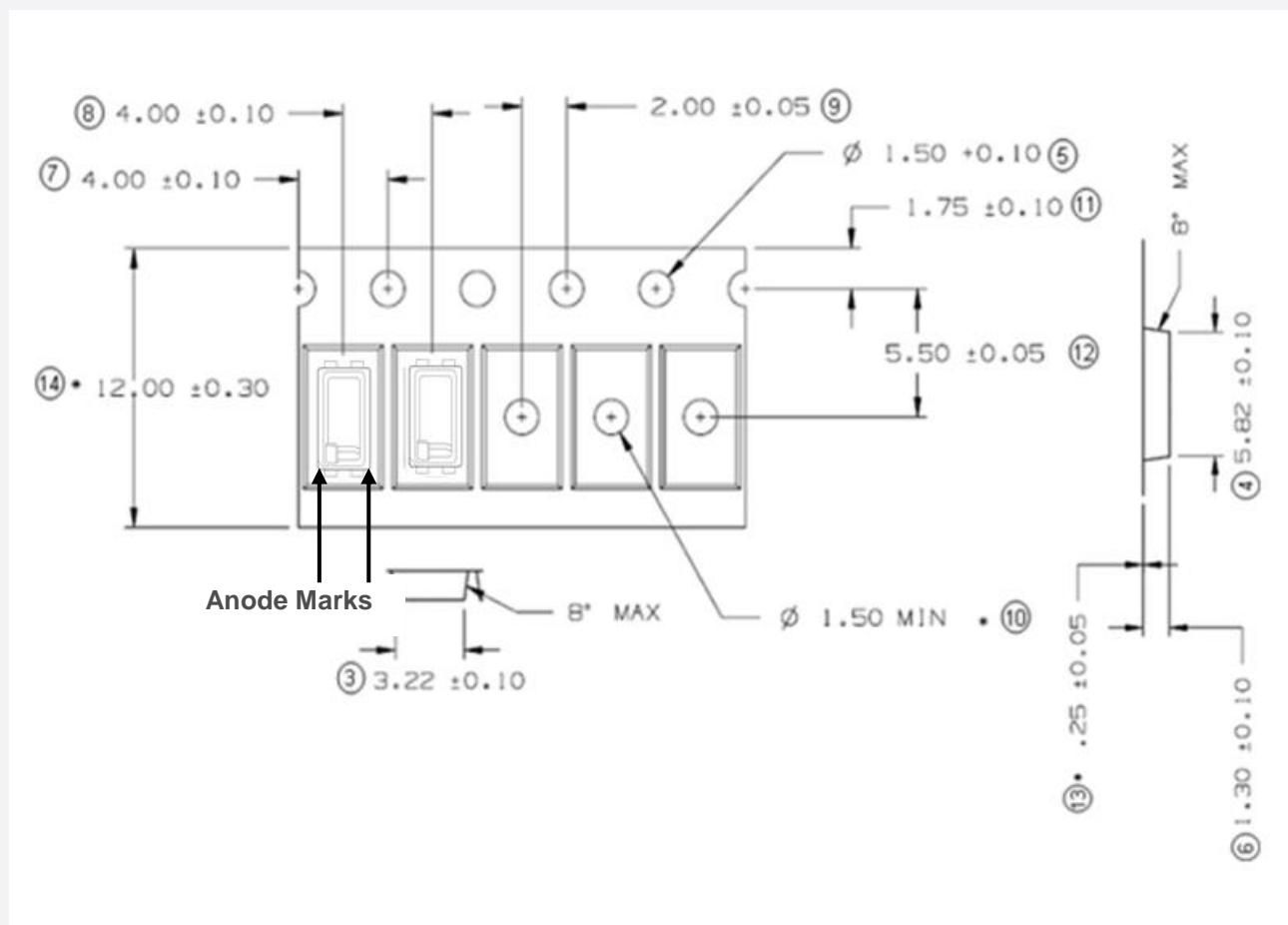
### b) Manual Soldering Conditions

Not more than 5 seconds @ max. 300 °C, under soldering iron.

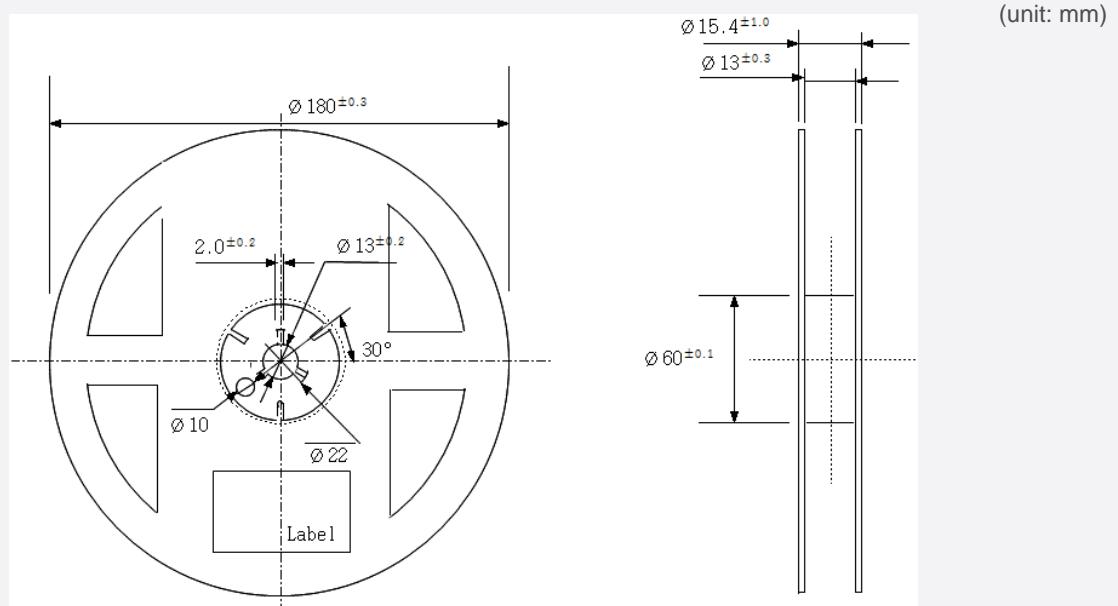
## 7. Tape & Reel

### a) Taping Dimension

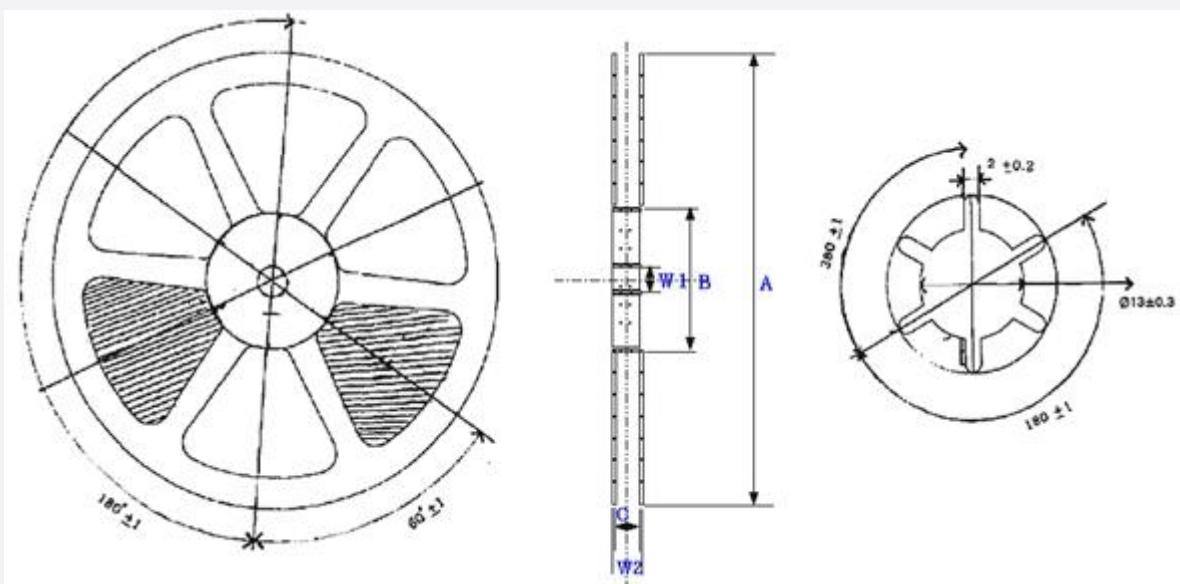
(unit: mm)



### b-1) Reel Dimension (Max 2,500 pcs)



### b-2) Reel Dimension (Max 10,000 pcs)



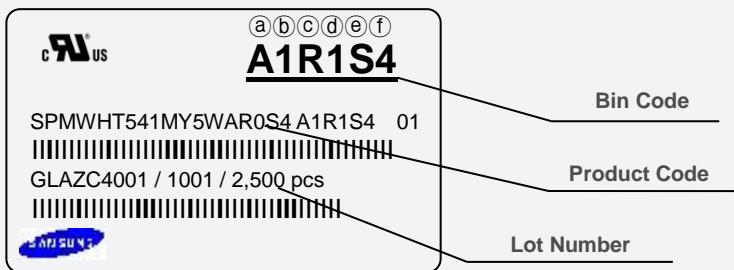
Symbol	A	B	C	W1	W2
Spec(mm)	Ø330±1	80±1	13±0.5	13±0.3	17.5±1

#### Notes:

- 1) Quantity: The quantity/reel is 2,500 or 10,000 pcs
- 2) Cumulative Tolerance: Cumulative tolerance / 10 pitches is  $\pm 0.2$  mm
- 3) Adhesion Strength of Cover Tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

## 8. Label Structure

### a) Label Structure



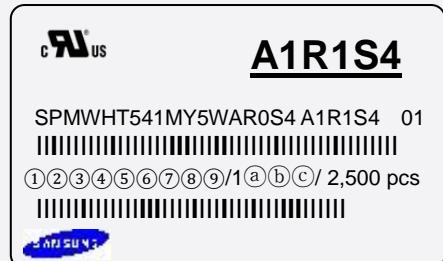
Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

- ⓐⓑ: Forward Voltage bin (refer to page 8)
- ⓒⓓ: Chromaticity bin (refer to page 10-13)
- ⓔⓕ: Luminous Flux bin (refer to page 8)

### b) Lot Number

The lot number is composed of the following characters:



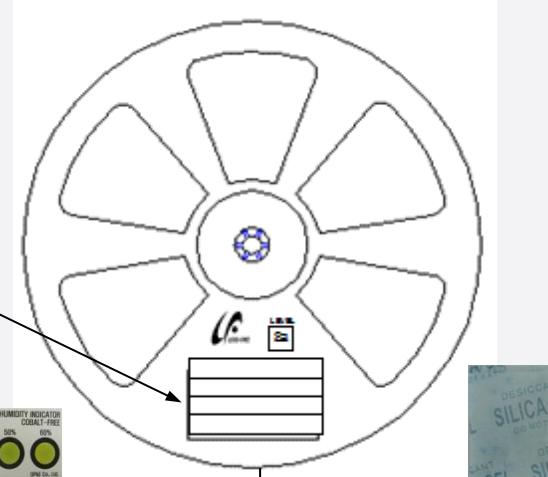
①②③④⑤⑥⑦⑧⑨ / 1ⓐⓑⓒ / 2,500 pcs

- ① : Production site (S: Giheung, Korea, G: Tianjin, China)
- ② : L (LED)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- ④ : Year (Z: 2015, A: 2016, B: 2017...)
- ⑤ : Month (1~9, A, B, C)
- ⑥⑦⑧⑨ : Day (1~9, A, B~V)
- ⓐⓑⓒ : Product serial number (001 ~ 999)

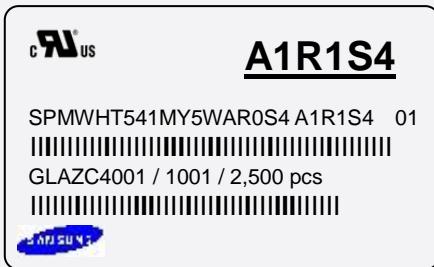
## 9. Packing Structure

### a-1) Packing Process (The quantity of PKG on the Reel to be Max 2,500pcs)

Reel



Aluminum Vinyl Packing Bag

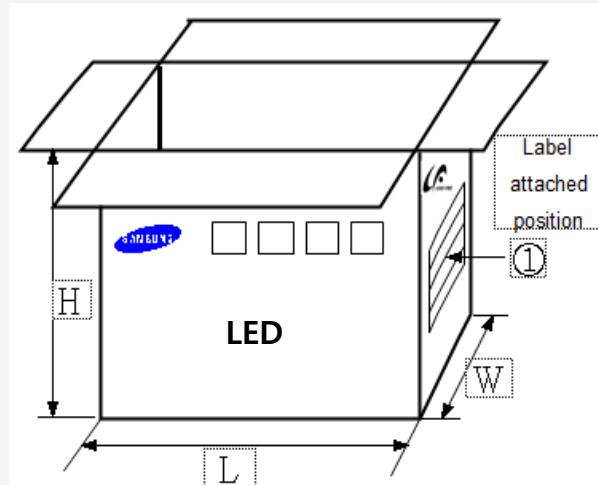
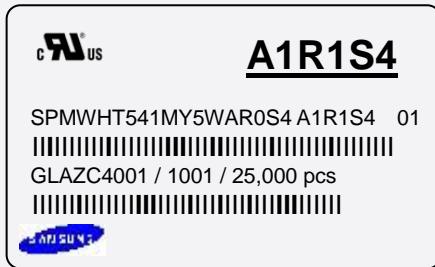


Outer Box

Material: Paper (SW3B(B))

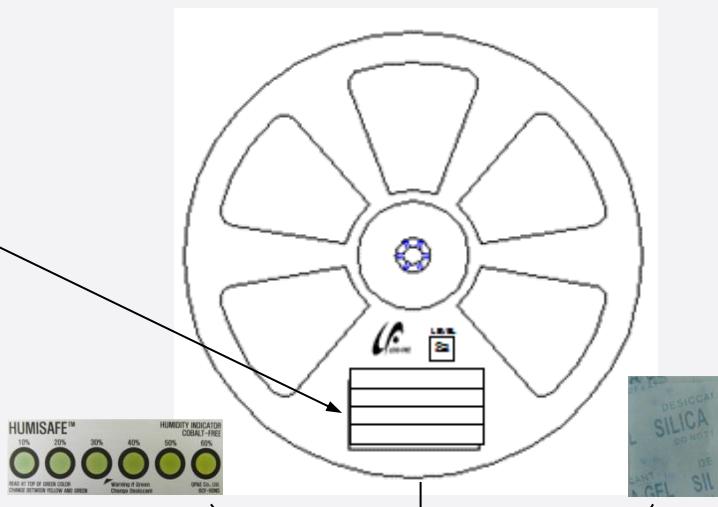
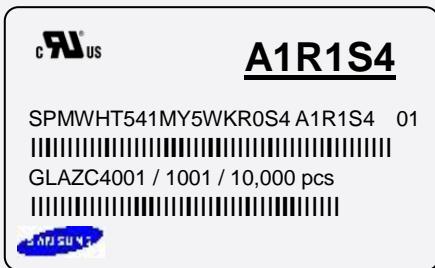
Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels
7 inch S	245 ± 5	220 ± 5	86 ± 5	Up to 5 reels

① Side Label

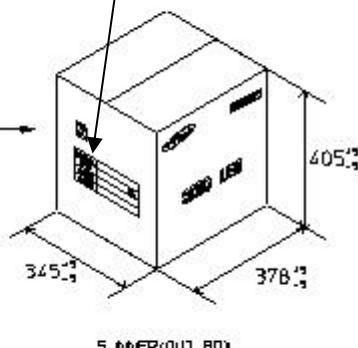
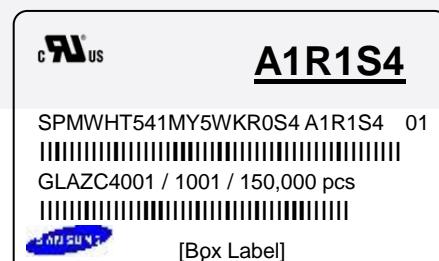
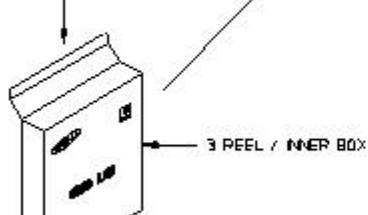
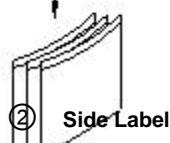
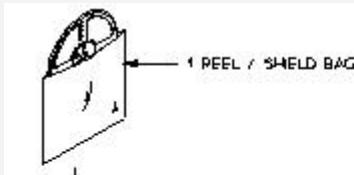
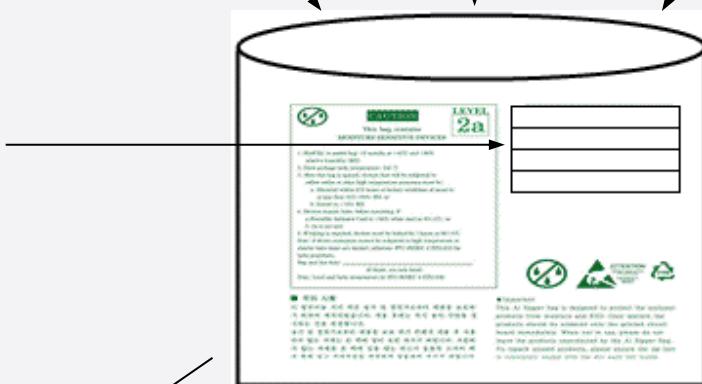
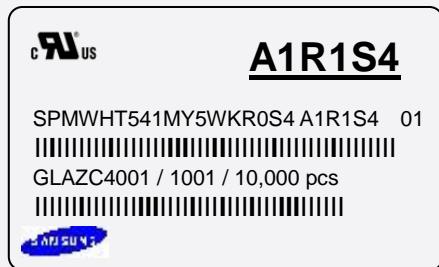


a-2) Packing Process (The quantity of PKG on the Reel to be Max 10,000pcs)

Reel



Aluminum Vinyl Packing Bag

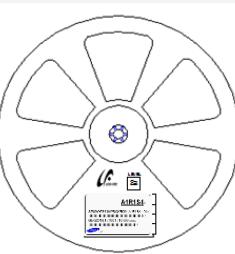


**b-1) Packing Process for kitting (The quantity of PKG on the Reel to be Max 2,500pcs)**

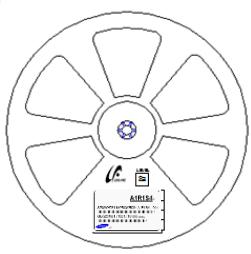
Reel



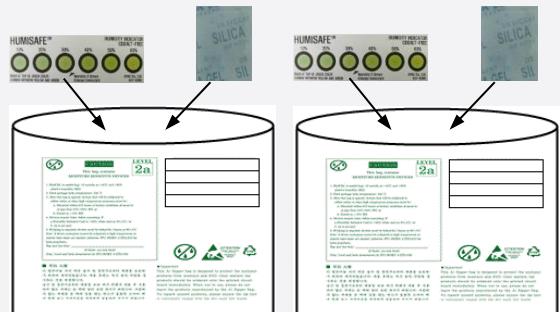
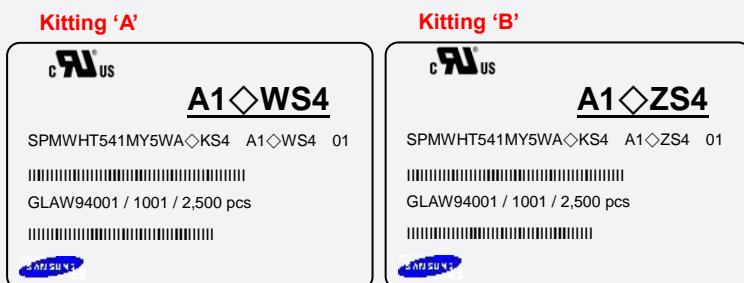
Kitting 'A'



Kitting 'B'



**Aluminum Vinyl Packing Bag**



Kitting 'A'

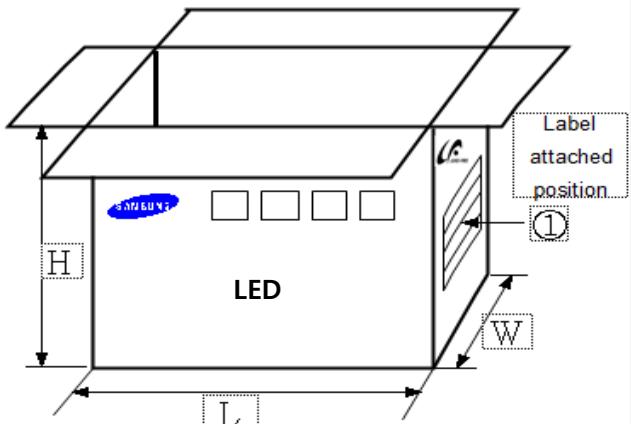


**Outer Box**

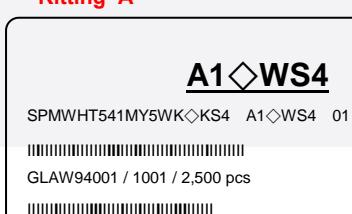
Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels

b-2) Pack



Kitting 'A'

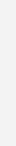
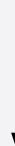


Kitting 'B'

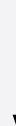
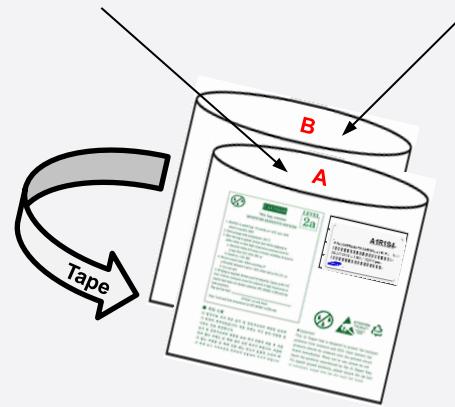


Reel to Max 10,000pcs)

**Reel**



**Aluminum Vinyl Packing Bag**



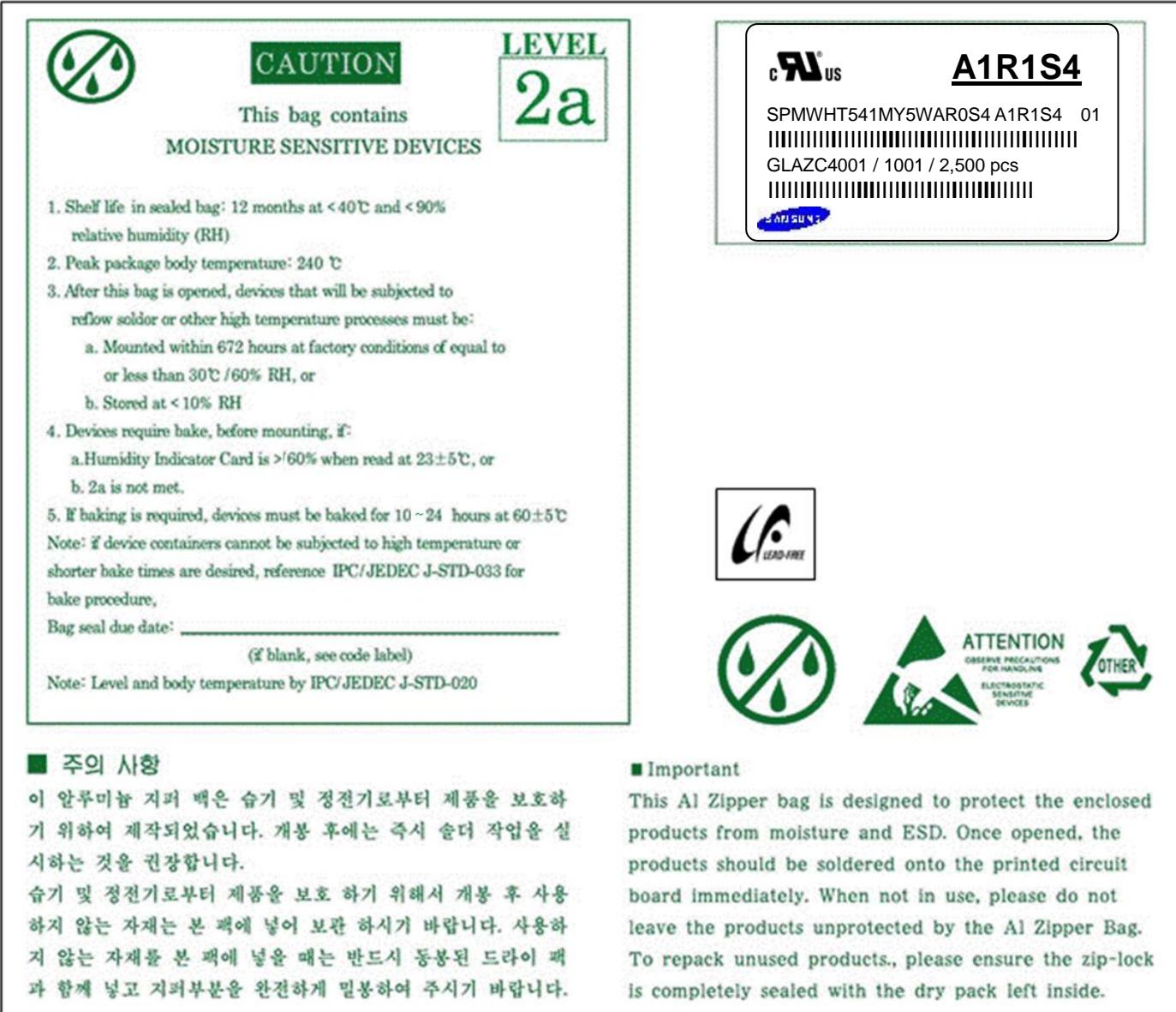
Note: "◊" can be Nominal CCT code.

**Material: Paper (SW3B(B))**

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels



c) Aluminum Vinyl Packing Bag



d) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag



## 10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
  - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH<sup>\*Note 1</sup>, or
  - b. Mounted within 24 hours (1 day) at an assembly line with a condition of more than 30 °C / 70 % RH<sup>\*Note 2</sup>, or
  - c. Stored at <10 % RH.

\*Note 1, 2: IPC/JEDEC J-STD-033A, Recommended Equivalent Total Floor Life Table

Package Type and Body Thickness	Moisture Sensitivity Level	Maximum Percent Relative Humidity							Temperature
		40%	50%	60%	70%	80%	90%		
Body Thickness <2.1mm	Level 2a	∞	∞	28	1	1	1	30°C	
		∞	∞	∞	2	1	1	26°C	
		∞	∞	∞	2	2	1	20°C	

- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 8) Devices must be baked for 10~24 hours at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) Risk of sulfurization (or tarnishing)  
The LED from Samsung uses a silver-plated lead frame and its surface color may change to black (or dark colored) when it is exposed to sulfur (S), chlorine (Cl) or other halogen compound. Sulfurization of lead frame may cause intensity degradation, change of chromaticity coordinates and, in extreme cases, open circuit. It requires caution. Due to possible sulfurization of lead frame, LED should not be used and stored together with oxidizing substances made of materials such as rubber, plain paper, lead solder cream, etc.



# Legal and additional information.

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